

## General Description

This MOSFET uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a battery protection or in other switching application.

## Features

- Low gate charge
- High power and current handling capability
- Lead free product is acquired

## Applications

- Load switch
- Battery protection
- Power management



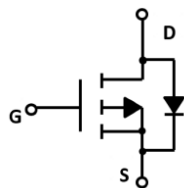
## Key Performance Parameters

Parameter	Value	Unit
$V_{DS}$	-60	V
$R_{DS(ON), max @ V_{GS}=-10V}$	155	m $\Omega$

## Marking Information

Product Name	Package	Marking
OSH2309	SOT-23	E4XX

## Package & Pin information



**Absolute Maximum Ratings** at  $T_j=25^{\circ}\text{C}$  unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	$V_{DS}$	-60	V
Gate-source voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	-2.2	A
Pulsed Drain Current <sup>1)</sup>	$I_{D,pulse}$	-9	A
Power Dissipation	$P_D$	1.3	mW
Operation and storage temperature	$T_{stg}, T_j$	-55 to 150	$^{\circ}\text{C}$

**Thermal Characteristics**

Parameter	Symbol	Value	Unit
Thermal resistance, junction-to-Ambient	$R_{\theta JA}$	100	$^{\circ}\text{C/W}$

**Electrical Characteristics** at  $T_j=25^{\circ}\text{C}$  unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	$BV_{DSS}$	-60			V	$V_{GS}=0\text{ V}, I_D=250\ \mu\text{A}$
Gate threshold voltage	$V_{GS(th)}$	-1		-2.5	V	$V_{DS}=V_{GS}, I_D=250\ \mu\text{A}$
Drain-source on-state resistance	$R_{DS(ON)}$		130	155	$\text{m}\Omega$	$V_{GS}=-10\text{ V}, I_D=-1.5\text{ A}$
			145	190	$\text{m}\Omega$	$V_{GS}=-4.5\text{ V}, I_D=-1\text{ A}$
Gate-source leakage current	$I_{GSS}$			100	$\mu\text{A}$	$V_{GS}=20\text{ V}, V_{DS}=0\text{ V}$
				-100		$V_{GS}=-20\text{ V}, V_{DS}=0\text{ V}$
Drain-source leakage current	$I_{DSS}$			-1	$\mu\text{A}$	$V_{DS}=-60\text{ V}, V_{GS}=0\text{ V}$

### Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	$C_{iss}$		970		pF	$V_{GS}=0\text{ V}$ , $V_{DS}=-30\text{ V}$ , $f=1.0\text{ MHz}$
Output capacitance	$C_{oss}$		33.4		pF	
Reverse transfer capacitance	$C_{rss}$		30		pF	
Turn-on Delay Time	$t_{d(on)}$		5.4		ns	$V_{GS}=-10\text{ V}$ , $V_{DD}=-30\text{ V}$ , $I_D=-2.2\text{ A}$ , $R_{GEN}=3\ \Omega$
Turn-on Rise Time	$t_r$		4		ns	
Turn-Off Delay Time	$t_{d(off)}$		70		ns	
Turn-Off Fall Time	$t_f$		18.5		ns	

### Gate Charge Characteristics

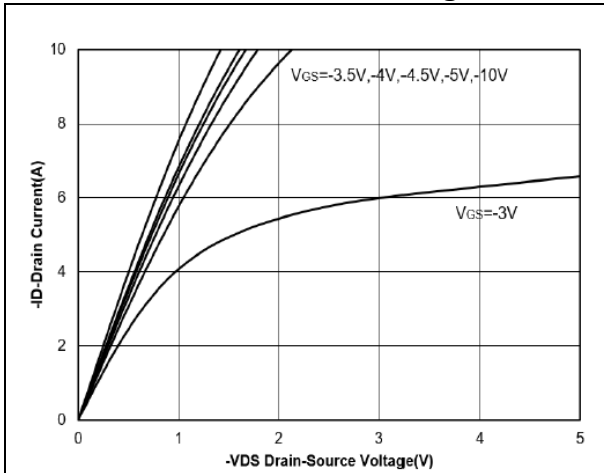
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total Gate Charge	$Q_g$		16.7		nC	$V_{GS}=-10\text{ V}$ , $V_{DS}=-30\text{ V}$ , $I_D=-2.2\text{ A}$
Gate-Source Charge	$Q_{gs}$		0.5		nC	
Gate-Drain Charge	$Q_{gd}$		1.6		nC	

### Body Diode Characteristics

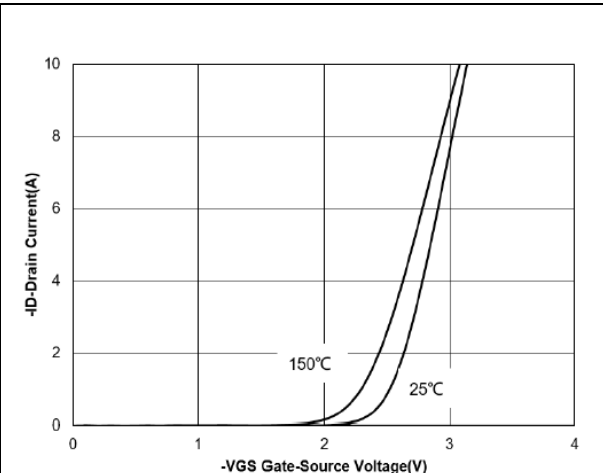
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Source drain current (Body Diode)	$I_{SD}$			-2.2	A	$T_A=25^\circ\text{C}$
Diode forward voltage <sup>2)</sup>	$V_{SD}$		-0.8	-1.2	V	$I_S=-2.2\text{ A}$ , $V_{GS}=0\text{ V}$

- Note:** 1) Pulse width limited by maximum allowable junction temperature.  
 2) Repetitive Rating: Pulse width limited by maximum junction temperature.

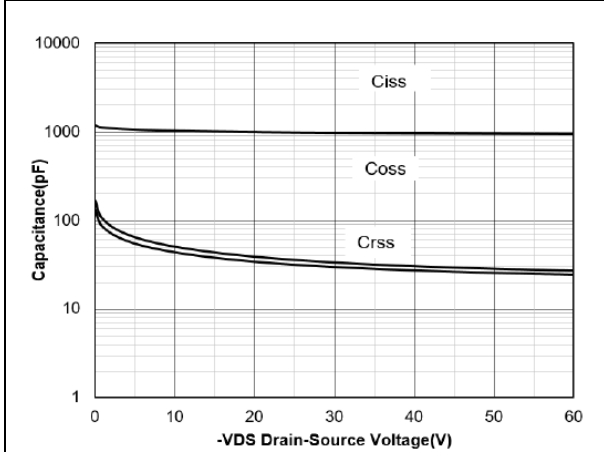
**Electrical Characteristics Diagrams**



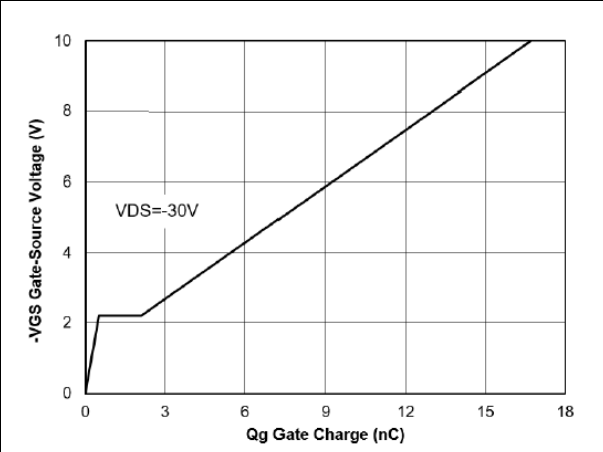
**Figure 1. Output characteristics**



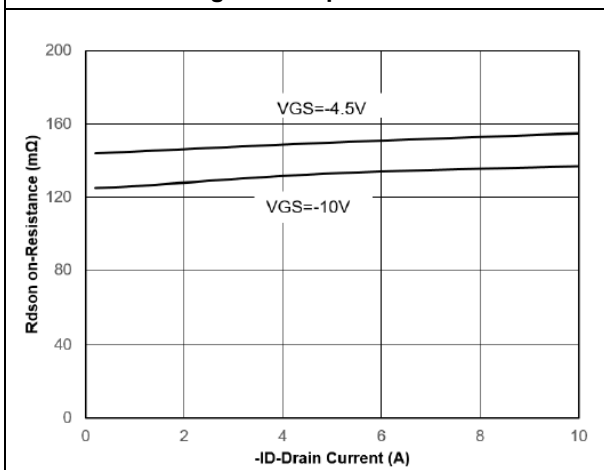
**Figure 2. Transfer characteristics**



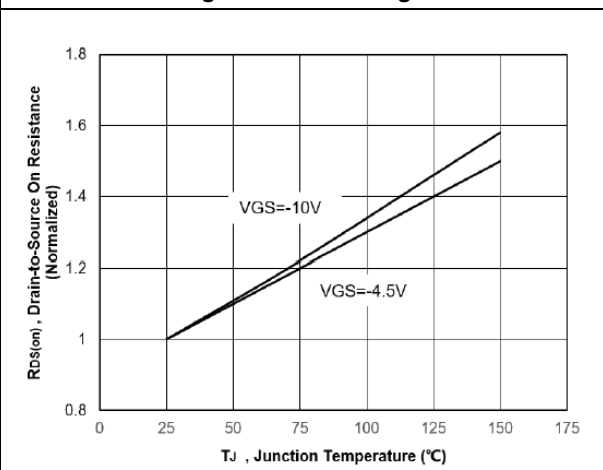
**Figure 3. Capacitances**



**Figure 4. Gate charge**

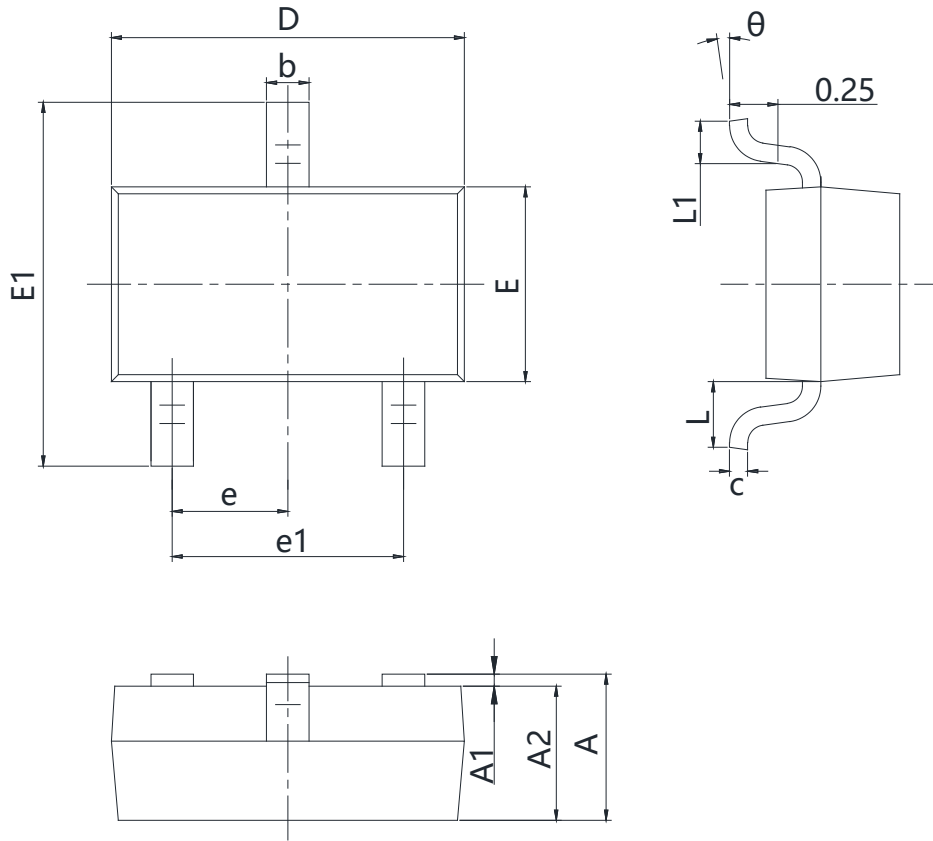


**Figure 5. Drain-Source on Resistance**



**Figure 6. RDS(ON) vs junction temperature**

**Package Information**



Symbol	mm	
	Min	Max
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
e	0.950 TYP	
e1	1.800	2.000
L	0.550 REF	
L1	0.300	0.500
$\theta$	0°	8°

Version: SOT-23-V package outline dimension

**Ordering Information**

Package Type	Units/ Reel	Reels/ Inner Box	Units/ Inner Box	Inner Boxes/ Carton Box	Units/ Carton Box
SOT-23	3000	10	30000	4	120000

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